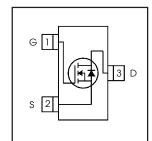
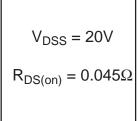
International Rectifier

IRLML2502

HEXFET® Power MOSFET

- Ultra Low On-Resistance
- N-Channel MOSFET
- SOT-23 Footprint
- Low Profile (<1.1mm)
- Available in Tape and Reel
- Fast Switching





Description

These N-Channel MOSFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET® power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in battery and load management.

A thermally enhanced large pad leadframe has been incorporated into the standard SOT-23 package to produce a HEXFET Power MOSFET with the industry's smallest footprint. This package, dubbed the Micro3™, is ideal for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro3 allows it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards. The thermal resistance and power dissipation are the best available.



Absolute Maximum Ratings

	Parameter	Max.	Units
V _{DS}	Drain- Source Voltage	20	V
$I_D @ T_A = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 4.5V	4.2	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 4.5V	3.4	Α
I _{DM}	Pulsed Drain Current ①	33	
P _D @T _A = 25°C	Power Dissipation	1.25	W
P _D @T _A = 70°C	Power Dissipation	0.8	VV
	Linear Derating Factor	0.01	W/°C
V_{GS}	Gate-to-Source Voltage	± 12	V
T _J , T _{STG}	Junction and Storage Temperature Range	-55 to + 150	°C

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient®	75	100	°C/W

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Ondraotoriotico © 1j = 20 C	(4				o operation)
	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	20			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.01		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		0.035	0.045		V _{GS} = 4.5V, I _D = 4.2A ②
TUS(on)	Static Brain to Gource Off Resistance		0.050	0.080	Ω	V _{GS} = 2.5V, I _D = 3.6A ②
V _{GS(th)}	Gate Threshold Voltage	0.60		1.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
g _{fs}	Forward Transconductance	5.8			S	$V_{DS} = 10V, I_D = 4.0A$
1	Drain-to-Source Leakage Current			1.0	^	V _{DS} = 16V, V _{GS} = 0V
I _{DSS}	Diali-to-Source Leakage Current			25	μΑ	$V_{DS} = 16V, V_{GS} = 0V, T_{J} = 70^{\circ}C$
1	Gate-to-Source Forward Leakage			-100	nA	V _{GS} = -12V
I _{GSS}	Gate-to-Source Reverse Leakage			100	11/4	V _{GS} = 12V
Qg	Total Gate Charge		8.0	12		$I_D = 4.0A$
Q _{gs}	Gate-to-Source Charge		1.8	2.7	nC	$V_{DS} = 10V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		1.7	2.6		V _{GS} = 5.0V ②
t _{d(on)}	Turn-On Delay Time		7.5			$V_{DD} = 10V$
t _r	Rise Time		10		ns	$I_D = 1.0A$
t _{d(off)}	Turn-Off Delay Time		54		115	$R_G = 6\Omega$
t _f	Fall Time		26			$R_D = 10\Omega$ ②
C _{iss}	Input Capacitance		740			$V_{GS} = 0V$
Coss	Output Capacitance		90		pF	$V_{DS} = 15V$
C _{rss}	Reverse Transfer Capacitance		66			f = 1.0MHz

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			4.0		MOSFET symbol
	(Body Diode)			1.3	A	showing the
I _{SM}	Pulsed Source Current			22	1 ^	integral reverse
	(Body Diode) ① 33	33	p-n junction diode.			
V _{SD}	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C$, $I_S = 1.3A$, $V_{GS} = 0V$ ②
t _{rr}	Reverse Recovery Time		16	24	ns	$T_J = 25^{\circ}C, I_F = 1.3A$
Q _{rr}	Reverse Recovery Charge		8.6	13	nC	di/dt = 100A/µs @

Notes:

- $\ensuremath{\mathbb{O}}$ Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② Pulse width ≤ 300µs; duty cycle ≤ 2%.

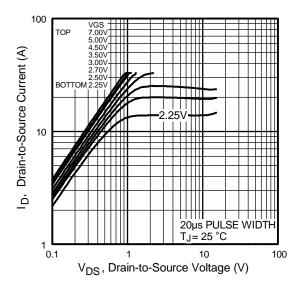


Fig 1. Typical Output Characteristics

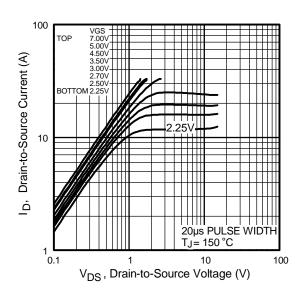


Fig 2. Typical Output Characteristics

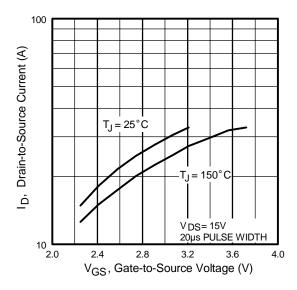


Fig 3. Typical Transfer Characteristics

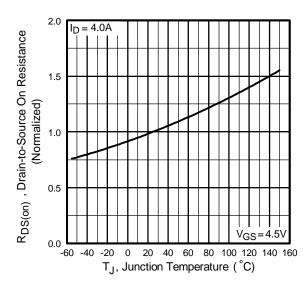


Fig 4. Normalized On-Resistance Vs. Temperature

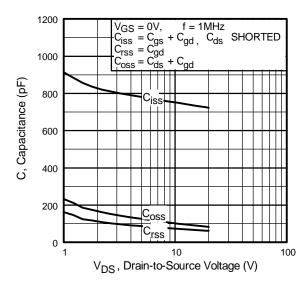


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

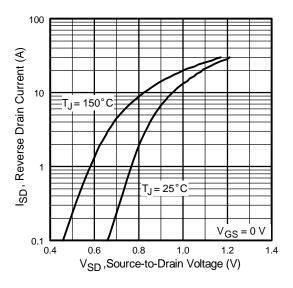


Fig 7. Typical Source-Drain Diode Forward Voltage

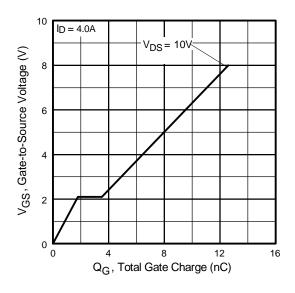


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

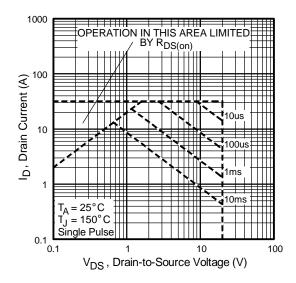


Fig 8. Maximum Safe Operating Area

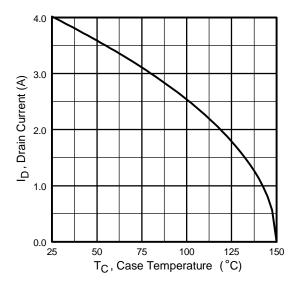


Fig 9. Maximum Drain Current Vs. Case Temperature

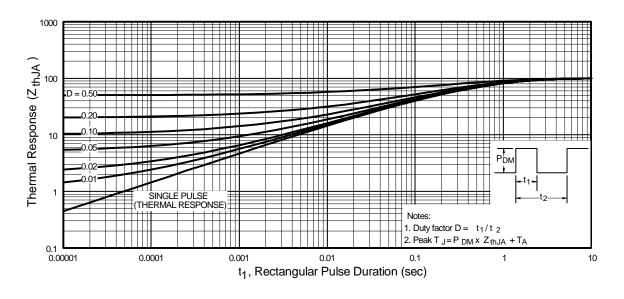


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

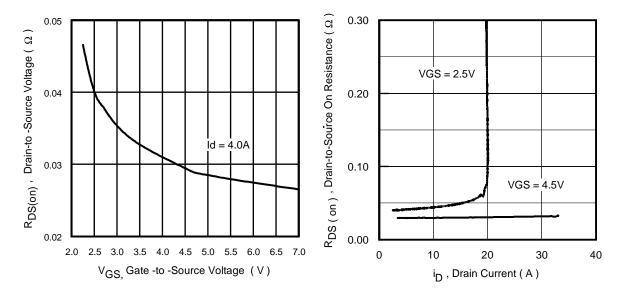


Fig 11. On-Resistance Vs. Gate Voltage

Fig 12. On-Resistance Vs. Drain Current

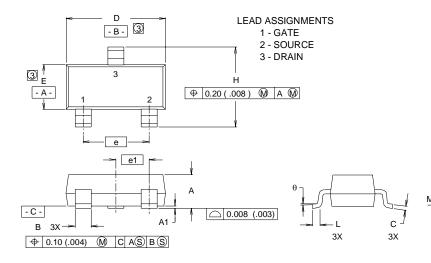
International

TOR Rectifier

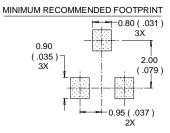
IRLML2502

Micro3™ Package Outline

Dimensions are shown in millimeters (inches)



DIM	INC	HES	MILLIMETERS		
	MIN	MAX	MIN	MAX	
Α	.032	.044	0.82	1.11	
A1	.001	.004	0.02	0.10	
В	.015	.021	0.38	0.54	
С	.004	.006	0.10	0.15	
D	.105	.120	2.67	3.05	
е	.0750	BASIC	1.90 BASIC		
e1	.0375	BASIC	0.95 BASIC		
Е	.047	.055	1.20	1.40	
Н	.083	.098	2.10	2.50	
L	.005	.010	0.13	0.25	
θ	0°	8°	0°	8°	



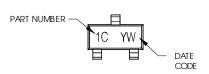
- NOTES:
 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
 2. CONTROLLING DIMENSION: INCH.
 3 DIMENSIONS DO NOT INCLUDE MOLD FLASH.

Part Marking Information

Micro3™

Notes: This part marking information applies to devices produced before 02/26/2001

EXAMPLE: THIS IS AN IRLML6302 WW = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR



YEAR	Υ	WORK WEEK	W
2001	1	01	Α
2002	2	02	В
2003	3	03	С
1994	4	04	D
1995	5		
1996	6		
1997	7		
1998	8		
1999	9	1	1
2000	0	24	X
		25	Υ
		26	7

International

TOR Rectifier

PART NUMBER CODE REFERENCE:

1A = IRLML2402 1B = IRLML2803 1C = IRLML6302 1D = IRLML5103 1E = IRLML6402 1F = IRLML6401 1G = IRLML2502 1H = IRLML5202

WW = (27-52) IF PRECEDED BY A LETTER

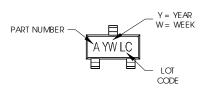
YEAR	Υ	WORK WEEK	W
2001	Α	27	Α
2002	В	28	В
2003	С	29	С
1994	D	30	D
1995	Е		
1996	F		
1997	G		
1998	Н	1	1
1999	J	1	7
2000	K	50	X
		51	Υ
		52	Z

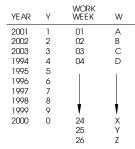
DATE CODE EXAMPLES:

YWW = 9503 = 5C YWW = 9532 = EF

Notes: This part marking information applies to devices produced after 02/26/2001

W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR





PART NUMBER CODE REFERENCE:

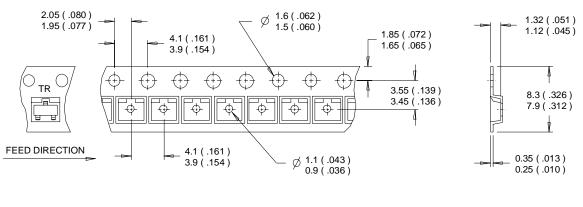
A= IRLM_2402 B= IRLM_2803 C= IRLM_6302 D= IRLM_5103 E= IRLM_6402 F= IRLM_6401 G= IRLML2502 H= IRLML5203

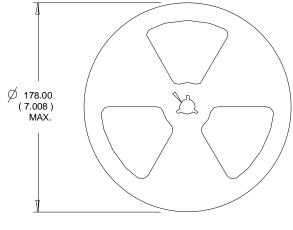
W= (27-52) IF PRECEDED BY A LETTER

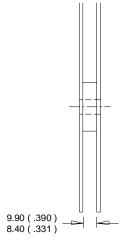
YEAR	Υ	WORK WEEK	W
2001	Α	27	Α
2002	В	28	В
2003	С	29	С
1994	D	30	D
1995	Е		1
1996	F		
1997	G		
1998	Н	1	1
1999	J	7	1
2000	K	50	Χ
		51	Υ
		52	Z

Micro3™ Tape & Reel Information

Dimensions are shown in millimeters (inches)







NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.



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